

# STC5NF20V

# N-channel 20V - 0.030Ω - 5A - TSSOP8 2.7V-drive STripFET™ II Power MOSFET

### **Features**

| Туре      | V <sub>DSS</sub> | R <sub>DS(on)</sub>                        | I <sub>D</sub> |
|-----------|------------------|--|----------------|
| STC5NF20V | 20V              | < 0.040 Ω (@ 4.5 V)<br>< 0.045 Ω (@ 2.7 V) | 5A             |

- Ultra low threshold gate drive (2.7V)
- Standard outline for easy automated surface mount assembly



■ Switching applications

### **Description**

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

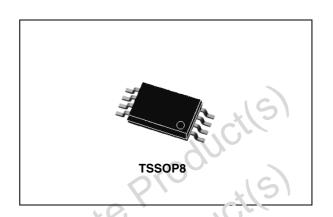


Figure 1. Internal schematic diagram

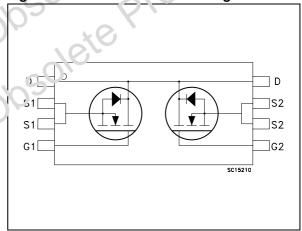


Table 1. Pevice summary

| Organ code | Marking | Package | Packaging   |
|------------|---------|---------|-------------|
| S C5NF20V  | 5N20V   | TSSOP8  | Tape & reel |

Contents STC5NF20V

### **Contents**

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STC5NF20V **Electrical ratings** 

#### **Electrical ratings** 1

**Absolute maximum ratings** Table 2.

| Symbol                         | Parameter   | Value      | Unit |
|--------------------------------|---|------------|------|
| $V_{DS}$                       | Drain-source voltage (V <sub>GS</sub> = 0)          | 20         | V    |
| V <sub>DGR</sub>               | Drain-gate voltage ( $R_{GS} = 20$ KΩ)              | 20         | V    |
| $V_{GS}$                       | Gate-source voltage                                 | ± 12       | V    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> = 25°C | 5          | Α    |
| I <sub>D</sub>                 | Drain current (continuous) at T <sub>C</sub> =100°C | 3          | Α    |
| I <sub>DM</sub> <sup>(1)</sup> | Drain current (pulsed)                              | 20         | Α    |
| P <sub>TOT</sub>               | Total dissipation at T <sub>C</sub> = 25°C          | 1.5        | W    |
| T <sub>stg</sub>               | Storage temperature                                 | -55 to 150 | °C   |
| TJ                             | Max. Operating junction temperature                 | -55 to 150 | °C   |

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

|                  | Symbol               | Parameter  | Value               | Unit |
|------------------|----------------------|--|---------------------|------|
|                  | R <sub>thJ-PBC</sub> | Thermal resistance junction-PBC Max                          | 100 (1)             | °C/W |
|                  | R <sub>thJ-PBC</sub> | Thermal resistance junction-PBC Max                          | 83.5 <sup>(2)</sup> | °C/W |
|                  |                      | Nounted on FR-4 board with 1 inch <sup>2</sup> pad, 2 oz. of | Cu. and t = 10 sec. |      |
| Obsole<br>Obsole | 2. When N            | Mounted on minimum recommended footprint                     |                     |      |

<sup>1.</sup> When Mounted on FR-4 board with 1 inch<sup>2</sup> pad, 2 oz. of Cu. and t = 10 sec.

<sup>2.</sup> When Mounted on minimum recommended footprint

STC5NF20V **Electrical characteristics** 

#### 2 **Electrical characteristics**

(T<sub>CASE</sub>=25°C unless otherwise specified)

Table 4. On/off states

| Symbol               | Parameter   | Test conditions   | Min. | Тур.           | Max.           | Unit     |
|----------------------|---|---|------|----------------|----------------|----------|
| V <sub>(BR)DSS</sub> | Drain-source breakdown voltage                        | $I_D = 250 \mu A, V_{GS} = 0$                                     | 20   |                |                | V        |
| I <sub>DSS</sub>     | Zero gate voltage drain current (V <sub>GS</sub> = 0) | $V_{DS} = Max rating,$<br>$V_{DS} = Max rating @ 125°C$           |      |                | 1<br>10        | μΑ<br>μΑ |
| I <sub>GSS</sub>     | Gate body leakage current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ±12V  |      | (              | ±100           | nA       |
| V <sub>GS(th)</sub>  | Gate threshold voltage                                | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                              | 0.6  | Q',            | ,              | ٧        |
| R <sub>DS(on)</sub>  | Static drain-source on resistance                     | $V_{GS}$ = 4.5V, $I_{D}$ = 2.5A<br>$V_{GS}$ =2.7V, $I_{D}$ = 2.5A | 240  | 0.030<br>0.037 | 0.040<br>0.045 | $\Omega$ |

Table 5. **Dynamic** 

| Symbol   | Parameter   | Test conditions                                    | Min. | Тур.              | Max. | Unit           |
|--|---|--|------|-------------------|------|----------------|
| g <sub>fs</sub> <sup>(1)</sup>                           | Forward transconductance  | $V_{DS} = 15 \text{ V}, I_D = 2.5 \text{A}$        |      | 9.5               |      | S              |
| C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub> | Input capacitance Output capacitance Reverse transfer capacitance | $V_{DS} = 15V, f = 1 \text{ MHz},$<br>$V_{GS} = 0$ |      | 460<br>200<br>50  |      | pF<br>pF<br>pF |
| Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub>     | Total gate charge<br>Gate-source charge<br>Gate-drain charge      | $V_{DD} = 10V, I_{D} = 4.5A$<br>$V_{GS} = 4.5V$    |      | 8.5<br>1.8<br>2.4 | 11.5 | nC<br>nC<br>nC |

|        | $C_{rss}$   | Reverse transfer capacitance  | $V_{GS} = 0$   |      | 50                  |      | pF             |
|--------|---|---|--|------|---------------------|------|----------------|
|        | $egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$                   | Total gate charge<br>Gate-source charge<br>Gate-drain charge        | $V_{DD} = 10V, I_D = 4.5A$<br>$V_{GS} = 4.5V$  |      | 8.5<br>1.8<br>2.4   | 11.5 | nC<br>nC<br>nC |
| 005018 | 1. Pulsed: p  | oulse duration=300μs, duty cycle Switching times                    | 1.5%   |      |                     |      |                |
| 0.     | Symbol  | Parameter   | Test conditions  | Min. | Тур.                | Max. | Unit           |
| Obsole | $egin{array}{l} t_{ m d(on)} & & & & & & & & & & & & & & & & & & &$ | Turn-on delay time<br>Rise time<br>Turn-off delay time<br>Fall time | $V_{DD}$ = 10V, $I_{D}$ = 2.5A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =4.5V Figure 14 on page 8 |      | 7<br>33<br>27<br>10 |      | ns<br>ns<br>ns |
|        | t <sub>d(off)</sub><br>t <sub>f</sub><br>t <sub>c</sub>             | Off-voltage rise time Fall time Cross-over time                     | Vclamp =16V, $I_D$ = 5A<br>$R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 4.5V<br>Figure 16 on page 8   |      | 26<br>11<br>21      |      | ns<br>ns<br>ns |

Table 7. Source drain diode

| IsD   Source-drain current   Source-drain current   Source-drain current   Source-drain current   Source-drain current   Source-drain current (pulsed)   Source-drain current (pulsed)   Source-drain current   Source-drain curren   | Symbol                         | Parameter                             | Test conditions  | Min. | Тур. | Max | Unit |
|--|--------------------------------|---------------------------------------|--|------|------|-----|------|
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$  |                                | Source-drain current                  |  |      |      | 5   | Α    |
| trr Qrr Reverse recovery charge Reverse recovery current I <sub>RRM</sub> I <sub>RRM</sub> Reverse recovery current I <sub>RRM</sub> I <sub>RRM</sub> Reverse recovery current I <sub>RRM</sub> |                                | Source-drain current (pulsed)         |  |      |      | 20  | Α    |
| In Pulse width limited by safe operating area  1. Pulsed: pulse duration=300μs, duty cycle 1.5%    In Pulse width limited by safe operating area   In Pulse width limited by   | V <sub>SD</sub> <sup>(2)</sup> | Forward on voltage                    | I <sub>SD</sub> = 5A, V <sub>GS</sub> = 0                    |      |      | 1.2 | ٧    |
| <ol> <li>Pulse width limited by safe operating area</li> <li>Pulsed: pulse duration=300μs, duty cycle 1.5%</li> </ol>  | Q <sub>rr</sub>                | Reverse recovery charge               | $di/dt = 100A/\mu s$ ,<br>$V_{DD} = 10V$ , $T_{.1} = 150$ °C |      | 13   |     | μC   |
|  | 2. Pulsed:                     | pulse duration=300μs, duty cycle 1.5% | josolete P   | ,,0  | 409  |     |      |

Electrical characteristics STC5NF20V

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

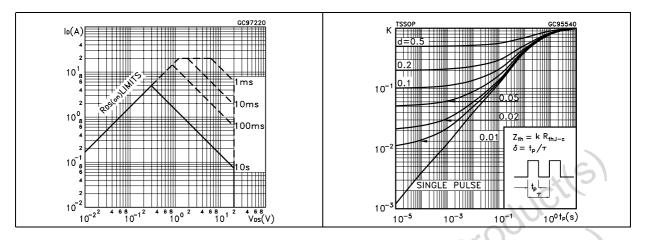


Figure 4. Output characteristics

Figure 5. Transfer characteristics

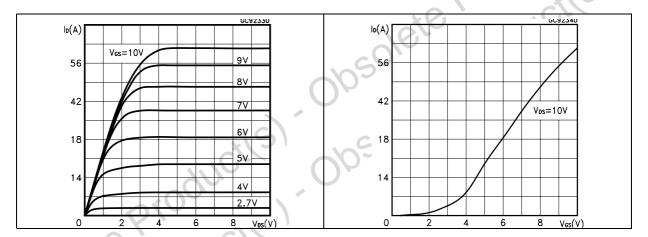


Figure 6. Transconductance

Figure 7. Static drain-source on resistance

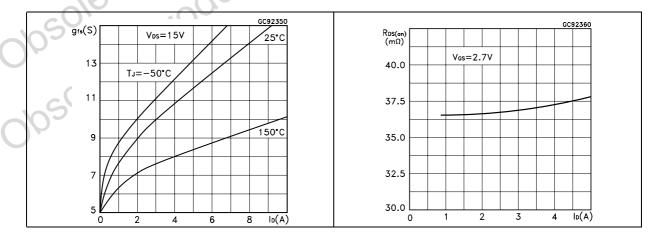


Figure 8. Gate charge vs. gate-source voltage Figure 9. Capacitance variations

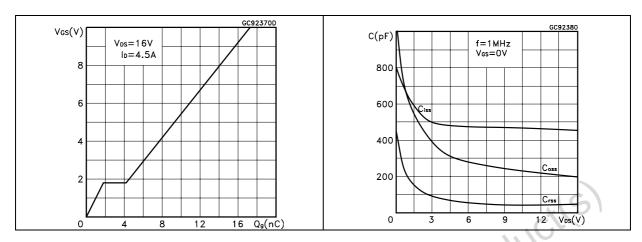


Figure 10. Normalized gate threshold voltage vs. temperature

Figure 11. Normalized on resistance vs. temperature

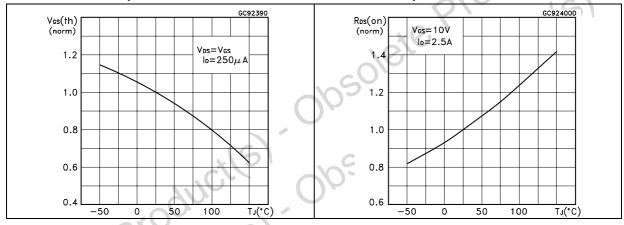
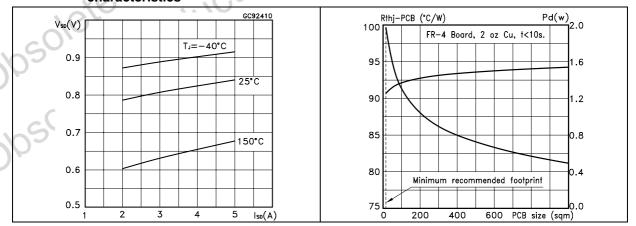


Figure 12. Source-drain diode forward characteristics

Figure 13. Thermal resistance and max power



Test circuit STC5NF20V

## 3 Test circuit

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

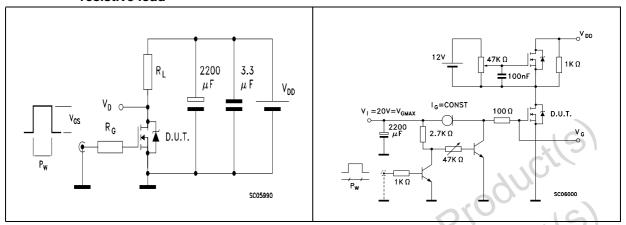


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped Inductive load test circuit

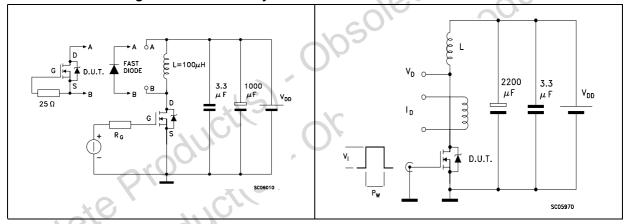
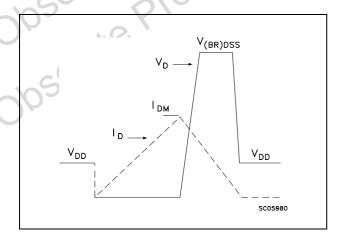


Figure 18. Unclamped inductive waveform



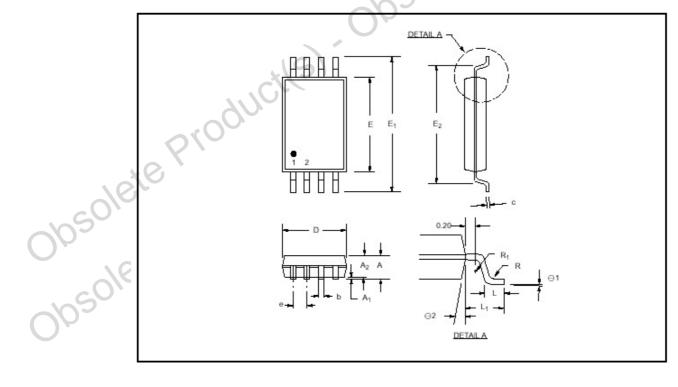
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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### **TSSOP8 MECHANICAL DATA**

| DIM. |      | mm.   |          |        | inch  |        |
|------|------|-------|----------|--------|-------|--------|
| DIW. | MIN. | TYP   | MAX.     | MIN.   | TYP.  | MAX.   |
| Α    | 1.05 |       | 1.20     | 0.041  |       | 0.047  |
| A1   | 0.05 |       | 0.15     | 0.002  |       | 0.006  |
| A2   | 0.80 |       | 1.05     | 0.032  |       | 0.041  |
| b    | 0.19 |       | 0.30     | 0.008  |       | 0.012  |
| С    |      | 0.127 |          |        | 0.005 |        |
| D    | 2.90 |       | 3.10     | 0.114  |       | 0.122  |
| Е    | 4.30 |       | 4.50     | 0.170  |       | 0.177  |
| E1   | 6.20 |       | 6.60     | 0.240  |       | 0.260  |
| E2   | 5.14 |       | 5.24     | 0.202  | 11.10 | 0.206  |
| е    |      | 0.65  |          |        | 0.025 |        |
| L    | 0.45 |       | 0.75     | 0.018  | 0     | 0.030  |
| L1   | 0.90 |       | 1.10     | 0.0355 |       | 0.0433 |
| R    | 0.09 |       |          | 0.004  |       |        |
| R1   | 0.09 |       |          | 0.004  |       |        |
| θ1   | 0°   |       | 8°       | O°     |       | 8°     |
| θ2   |      |       | <u> </u> | ް      |       |        |



STC5NF20V Revision history

## 5 Revision history

Table 8. Document revision history

| Date        |
|-------------|
| 09-Sep-2004 |
| 03-Aug-2006 |
| 01-Feb-2007 |
| 25-Oct-2007 |
| s Prof      |

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